

# TC74AC157P, TC74AC157F, TC74AC157FT

## Quad 2-Channel Multiplexer

The TC74AC157 is an advanced high speed CMOS QUAD 2-CHANNEL MULTIPLEXER fabricated with silicon gate and double-layer metal wiring C<sup>2</sup>MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

This device consist of four 2-input digital multiplexer with common select and strobe inputs.

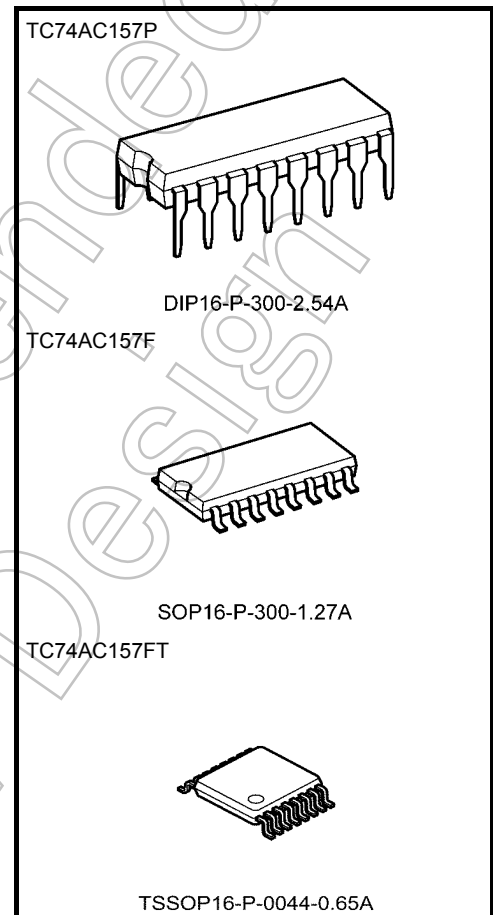
When the STROBE input is held "H" level, selection of data is inhibited and all the outputs become "L" level.

The SELECT decoding determines whether the A or B inputs get routed to their corresponding Y outputs.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

### Features

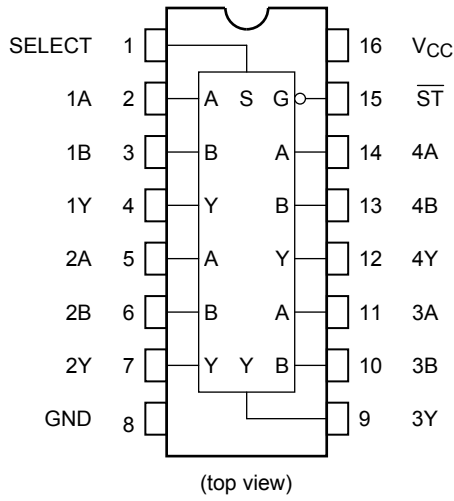
- High speed:  $t_{pd} = 4.5 \text{ ns (typ.) at } V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 8 \mu\text{A (max) at } T_a = 25^\circ\text{C}$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC} \text{ (min)}$
- Symmetrical output impedance:  $|I_{OH}| = I_{OL} = 24 \text{ mA (min)}$   
 Capability of driving 50  $\Omega$  transmission lines.
- Balanced propagation delays:  $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range:  $V_{CC(opr)} = 2 \text{ to } 5.5 \text{ V}$
- Pin and function compatible with 74F157



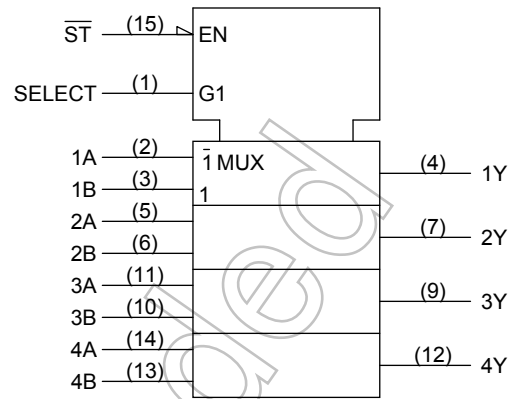
Weight	
DIP16-P-300-2.54A	: 1.00 g (typ.)
SOP16-P-300-1.27A	: 0.18 g (typ.)
TSSOP16-P-0044-0.65A	: 0.06 g (typ.)

Start of commercial production  
1987-05

**Pin Assignment**



**IEC Logic Symbol**



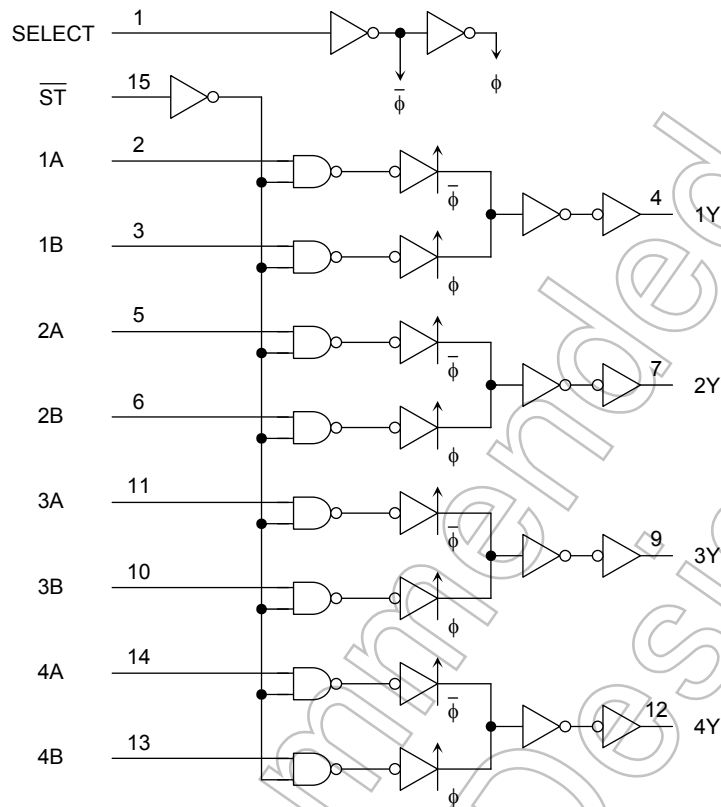
**Truth Table**

Inputs				Output
ST-bar	SELECT	A	B	Y
H	X	X	X	L
L	L	L	X	L
L	L	H	X	H
L	H	X	L	L
L	H	X	H	H

X: Don't care

Not Recommended for New Design

**System Diagram**



**Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	$V_{CC}$	-0.5 to 7.0	V
DC input voltage	$V_{IN}$	-0.5 to $V_{CC} + 0.5$	V
DC output voltage	$V_{OUT}$	-0.5 to $V_{CC} + 0.5$	V
Input diode current	$I_{IK}$	$\pm 20$	mA
Output diode current	$I_{OK}$	$\pm 50$	mA
DC output current	$I_{OUT}$	$\pm 50$	mA
DC $V_{CC}$ /ground current	$I_{CC}$	$\pm 100$	mA
Power dissipation	$P_D$	500 (DIP) (Note 2)/180 (SOP/TSSOP)	mW
Storage temperature	$T_{stg}$	-65 to 150	$^{\circ}C$

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of  $T_a = -40$  to  $65^{\circ}C$ . From  $T_a = 65$  to  $85^{\circ}C$ , a derating factor of  $-10$  mW/ $^{\circ}C$  should be applied up to 300 mW.

## Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	$V_{CC}$	2.0 to 5.5	V
Input voltage	$V_{IN}$	0 to $V_{CC}$	V
Output voltage	$V_{OUT}$	0 to $V_{CC}$	V
Operating temperature	$T_{opr}$	-40 to 85	°C
Input rise and fall time	dt/dV	0 to 100 ( $V_{CC} = 3.3 \pm 0.3$ V) 0 to 20 ( $V_{CC} = 5 \pm 0.5$ V)	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device.  
Unused inputs must be tied to either  $V_{CC}$  or GND.

## Electrical Characteristics

### DC Characteristics

Characteristics	Symbol	Test Condition	$T_a = 25^\circ\text{C}$			$T_a = -40$ to $85^\circ\text{C}$		Unit		
			$V_{CC}$ (V)	Min	Typ.	Max	Min		Max	
High-level input voltage	$V_{IH}$	—	2.0	1.50	—	—	1.50	—	V	
			3.0	2.10	—	—	2.10	—		
			5.5	3.85	—	—	3.85	—		
Low-level input voltage	$V_{IL}$	—	2.0	—	—	0.50	—	0.50	V	
			3.0	—	—	0.90	—	0.90		
			5.5	—	—	1.65	—	1.65		
High-level output voltage	$V_{OH}$	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OH} = -50 \mu\text{A}$	2.0	1.9	2.0	—	1.9	—	V
			$I_{OH} = -4 \text{ mA}$	3.0	2.58	—	—	2.48	—	
			$I_{OH} = -24 \text{ mA}$	4.5	3.94	—	—	3.80	—	
			$I_{OH} = -75 \text{ mA}$ (Note)	5.5	—	—	—	3.85	—	
Low-level output voltage	$V_{OL}$	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OL} = 50 \mu\text{A}$	2.0	—	0.0	0.1	—	0.1	V
			$I_{OL} = 12 \text{ mA}$	3.0	—	—	0.36	—	0.44	
			$I_{OL} = 24 \text{ mA}$	4.5	—	—	0.36	—	0.44	
			$I_{OL} = 75 \text{ mA}$ (Note)	5.5	—	—	—	—	1.65	
Input leakage current	$I_{IN}$	$V_{IN} = V_{CC}$ or GND	5.5	—	—	$\pm 0.1$	—	$\pm 1.0$	$\mu\text{A}$	
Quiescent supply current	$I_{CC}$	$V_{IN} = V_{CC}$ or GND	5.5	—	—	8.0	—	80.0	$\mu\text{A}$	

Note: This spec indicates the capability of driving 50  $\Omega$  transmission lines.

One output should be tested at a time for a 10 ms maximum duration.

### AC Characteristics ( $C_L = 50 \text{ pF}$ , $R_L = 500 \text{ } \Omega$ , input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Ta = 25°C			Ta = -40 to 85°C		Unit
				Min	Typ.	Max	Min	Max	
Propagation delay time (A, B-Y)	t <sub>pLH</sub>	—	3.3 ± 0.3	—	7.2	12.2	1.0	14.0	ns
	t <sub>pHL</sub>		5.0 ± 0.5	—	5.5	7.9	1.0	9.1	
Propagation delay time (SELECT-Y)	t <sub>pLH</sub>	—	3.3 ± 0.3	—	8.5	14.5	1.0	16.7	ns
	t <sub>pHL</sub>		5.0 ± 0.5	—	6.3	9.1	1.0	10.5	
Propagation delay time ( $\overline{ST}$ -Y)	t <sub>pLH</sub>	—	3.3 ± 0.3	—	8.6	14.6	1.0	16.8	ns
	t <sub>pHL</sub>		5.0 ± 0.5	—	6.4	9.2	1.0	10.6	
Input capacitance	C <sub>IN</sub>	—	—	5	10	—	10	pF	
Power dissipation capacitance	C <sub>PD</sub>	(Note)	—	93	—	—	—	pF	

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

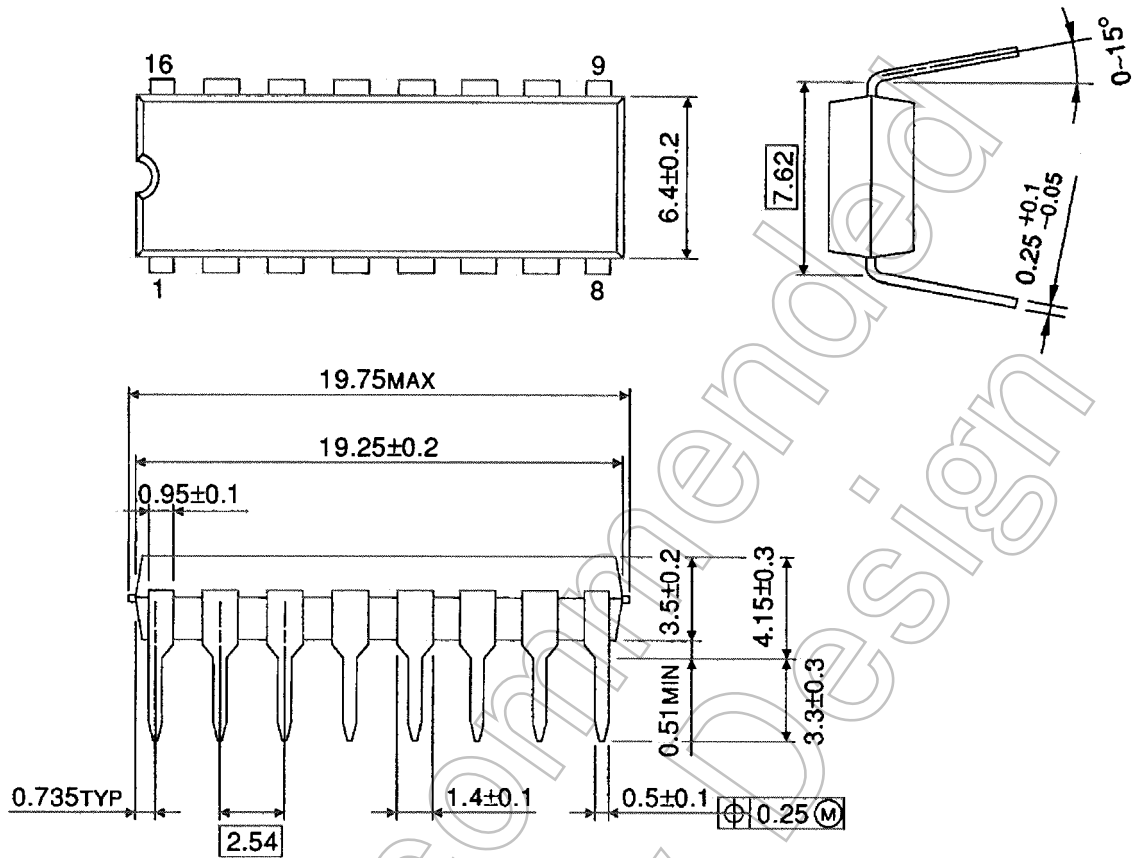
$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4 \text{ (per bit)}$$

Not Recommended for New Designs

**Package Dimensions**

DIP16-P-300-2.54A

Unit : mm



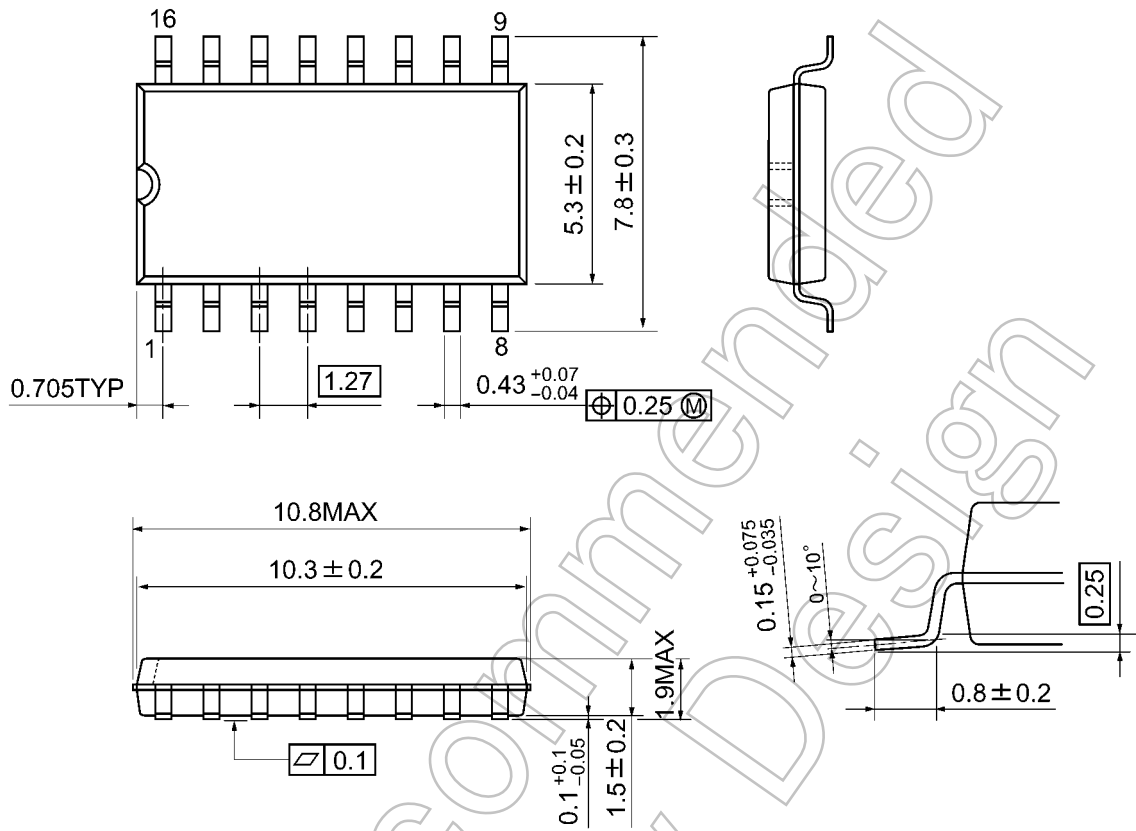
Weight: 1.00 g (typ.)

Not Recommended for New Design

**Package Dimensions**

SOP16-P-300-1.27A

Unit: mm



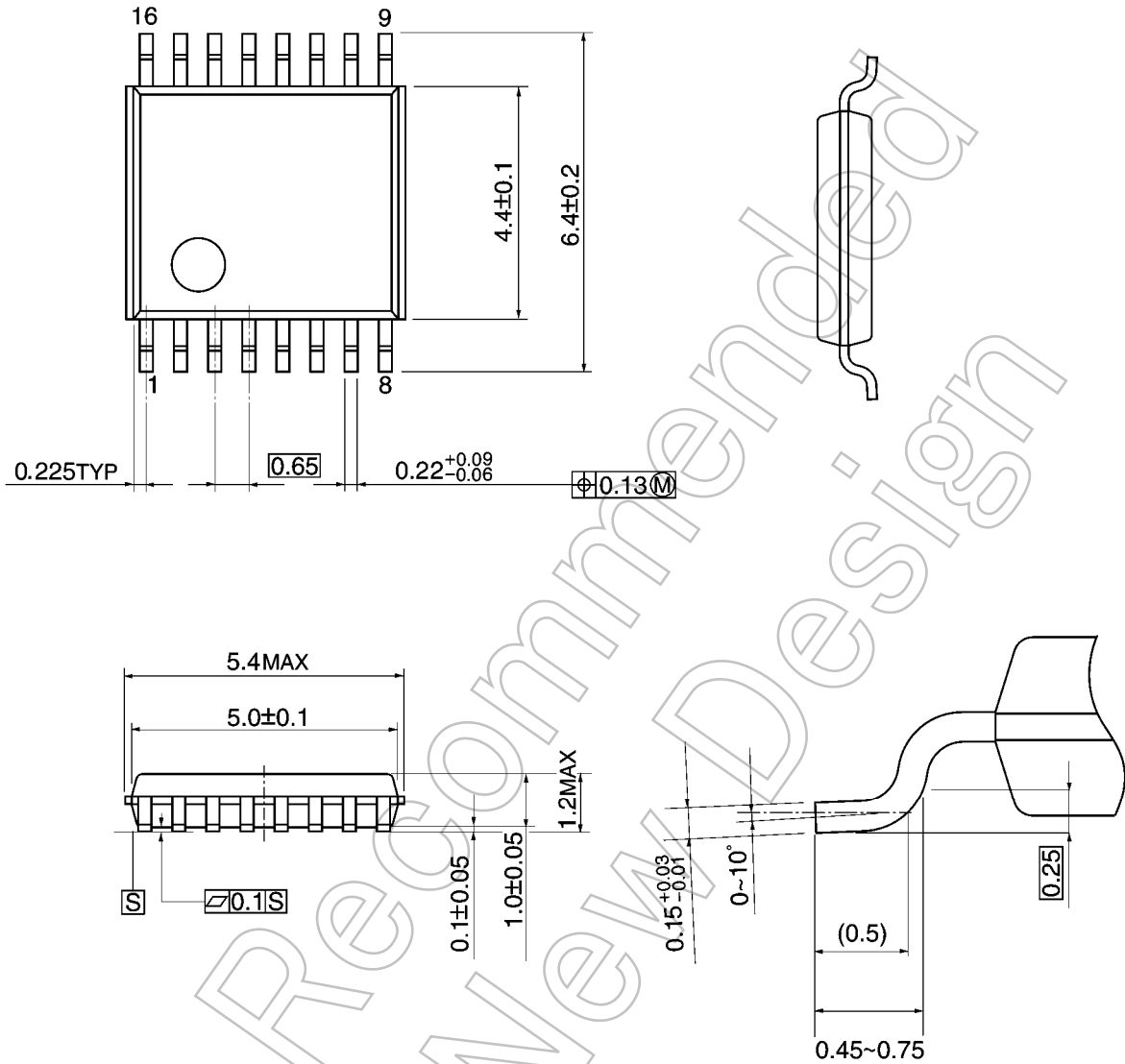
Weight: 0.18 g (typ.)

Not Recommended for New Design

**Package Dimensions**

TSSOP16-P-0044-0.65A

Unit: mm



Weight: 0.06 g (typ.)

Not Recommended for New Design



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